Product Summary

$V_{(BR)DSS}$	$R_{DS(on)TYP}$	I_D
100V	1.7mΩ@10V	300A

合肥矽普半导体
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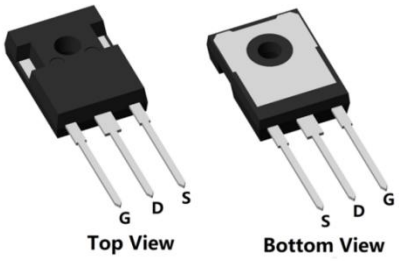
Feature

- Fast Switching
- Low Gate Charge and Rdson
- Advanced Split Gate Trench Technology
- 100% Single Pulse avalanche energy Test

Applications

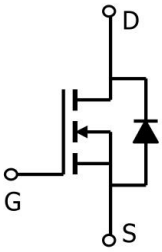
- Power switching application
- DC-DC Converter
- Power Management

Package

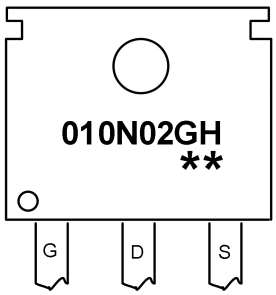


TO-247(1:G 2:D 3:S)

Circuit diagram



Marking



010N02GH : Product code
**** : Week code**

Order Information

Device	Package	Unit/Tube
SP010N02GHTF	TO-247	30

Absolute maximum ratings (Ta=25℃,unless otherwise noted)

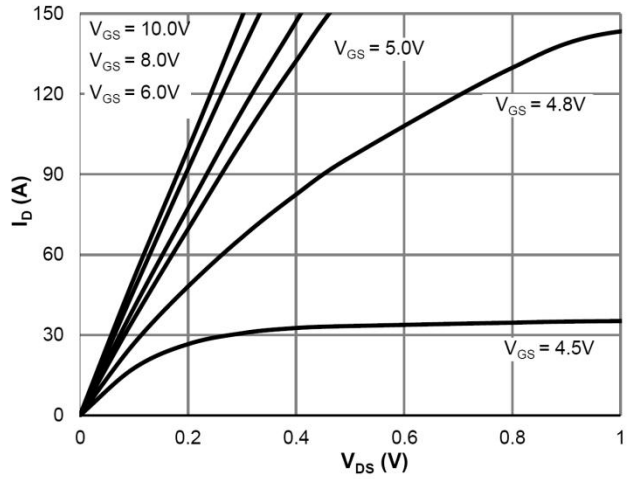
Parameter	Symbol	Rating	Units
Drain-Source Voltage	V_{DS}	100	V
Gate-Source Voltage	V_{GS}	±20	V
Continuous Drain Current (Tc=25℃)	I_D	300	A
Continuous Drain Current (Tc=100℃)	I_D	200	A
Pulsed Drain Current	I_{DM}	1200	A
Single Pulse Avalanche Energy[1]	E_{AS}	1650	mJ
Power Dissipation (Tc=25℃)	P_D	300	W
Thermal Resistance Junction-to-Case	$R_{\theta JC}$	0.42	℃/W
Storage Temperature Range	T_{STG}	-55 to 150	℃
Operating Junction Temperature Range	T_J	-55 to 150	℃

Electrical characteristics (Ta=25℃, unless otherwise noted)

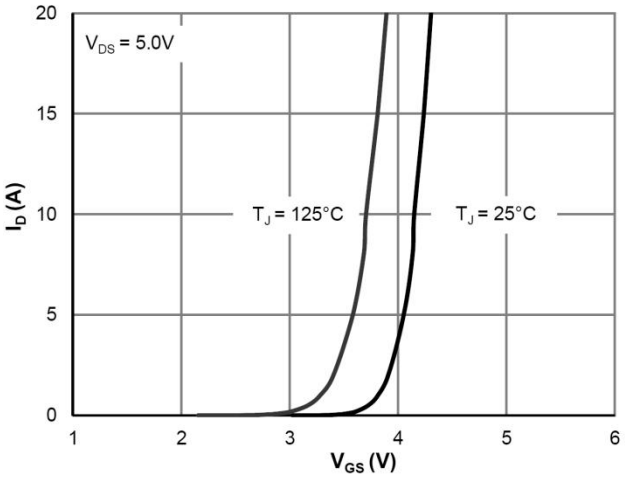
Characteristics	Symbol	Test Condition	Min	Typ	Max	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	VGS=0V , ID=250uA	100	-	-	V
Drain Cut-Off Current	I_{DSS}	VDS=80V , VGS=0V , TJ=25℃	-	-	1	μA
Gate Leakage Current	I_{GSS}	VGS=±20V , VDS=0V	-	-	±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	VGS=VDS , ID =250uA	2	2.7	4	V
Drain-Source ON Resistance	$R_{DS(ON)}$	VGS=10V , ID=20A	-	1.7	2.2	mΩ
Dynamic Characteristics						
Input Capacitance	C_{iss}	VDS=50V , VGS=0V , f=1MHz	-	13420	-	pF
Output Capacitance	C_{oss}		-	2034	-	
Reverse Transfer Capacitance	C_{rss}		-	48	-	
Total Gate Charge	Q_g	VDS=50V , VGS=10V , ID=125A	-	156	-	nC
Gate-Source Charge	Q_{gs}		-	51	-	
Gate-Drain Charge	Q_{gd}		-	45	-	
Switching Characteristics						
Turn-On Delay Time	$t_{d(on)}$	VDD=50V, VGS=10V , RG=1.6Ω, ID=125A	-	35	-	nS
Rise Time	t_r		-	68	-	
Turn-Off Delay Time	$t_{d(off)}$		-	150	-	
Fall Time	t_f		-	105	-	
Drain-Source Body Diode Characteristics						
Source-Drain Diode Forward Voltage	V_{SD}	I_S = 1A, VGS = 0V	-	-	1.2	V
Maximum Body-Diode Continuous Current	I_S		-	-	300	A
Reverse Recovery Time	Trr	I_S=50A, di/dt=100A/us, TJ=25℃	-	106	-	nS
Reverse Recovery Charge	Qrr		-	328	-	nC

Note :
The test condition is VDD=50V,VGS=10V,L=0.5mH,RG=25Ω

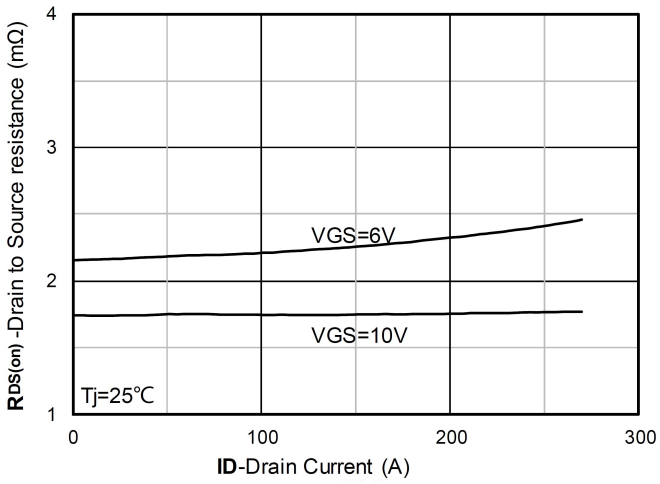
Typical Characteristics



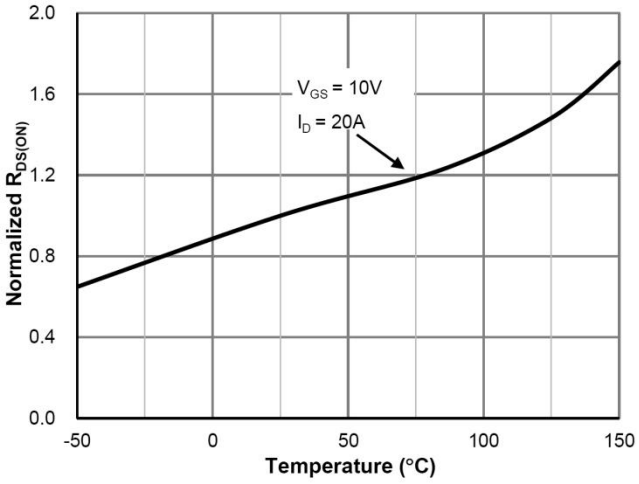
Saturation Characteristics



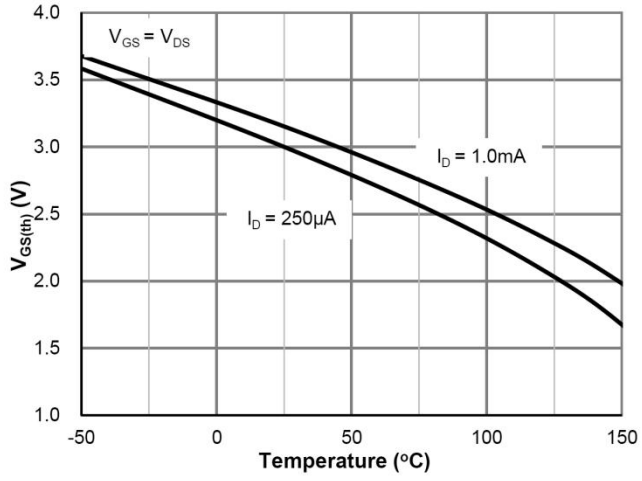
Transfer Characteristics



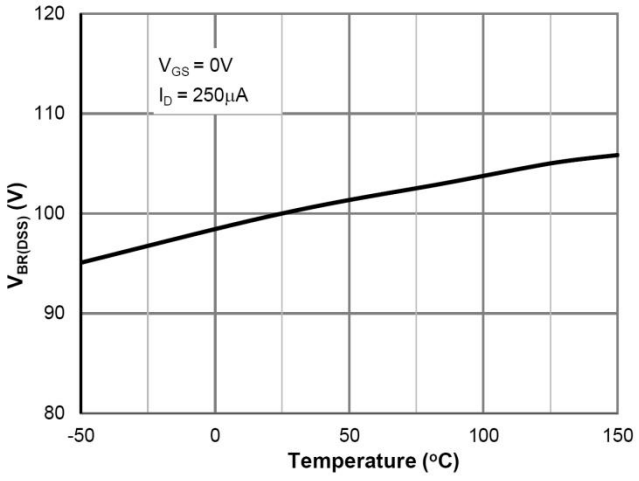
$R_{DS(ON)}$ vs. Drain Current



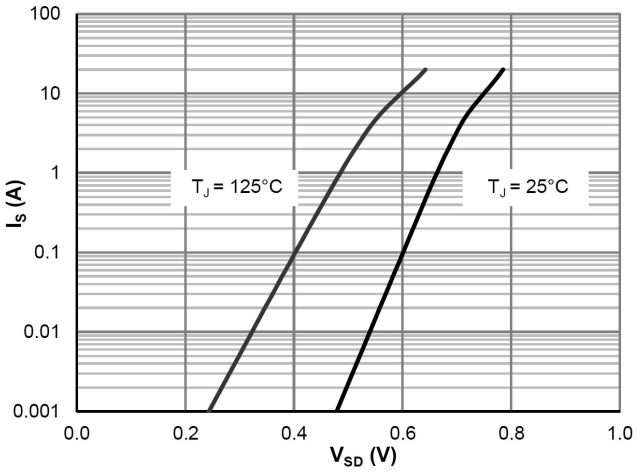
$R_{DS(ON)}$ vs. Junction Temperature



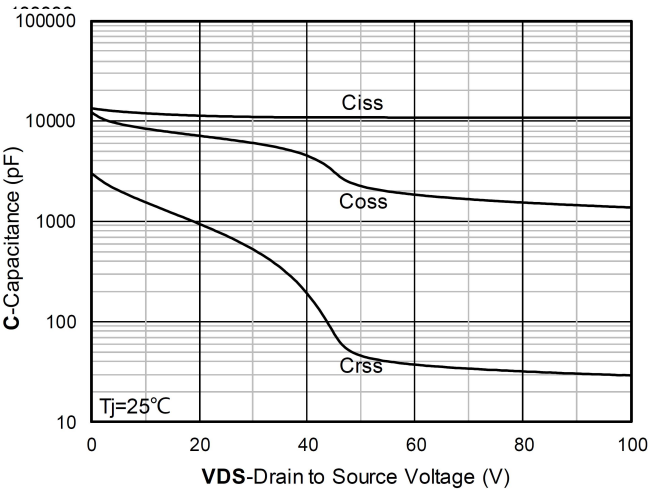
$V_{GS(th)}$ vs. Junction Temperature



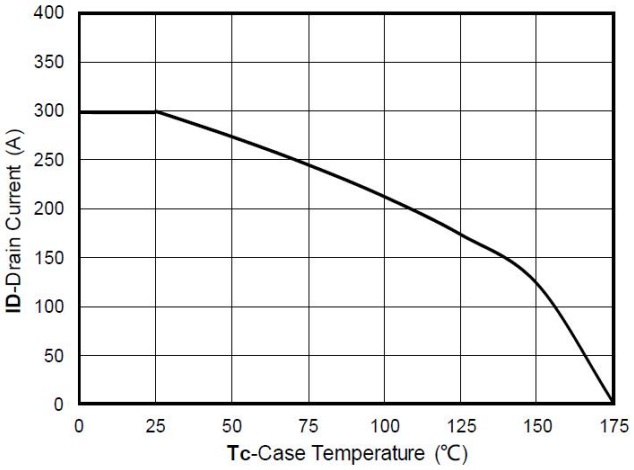
$V_{BR(DSS)}$ vs. Junction Temperature



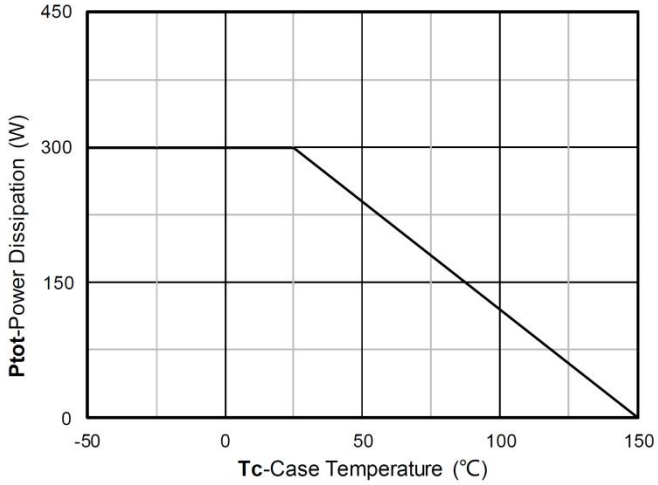
Body-Diode Characteristics



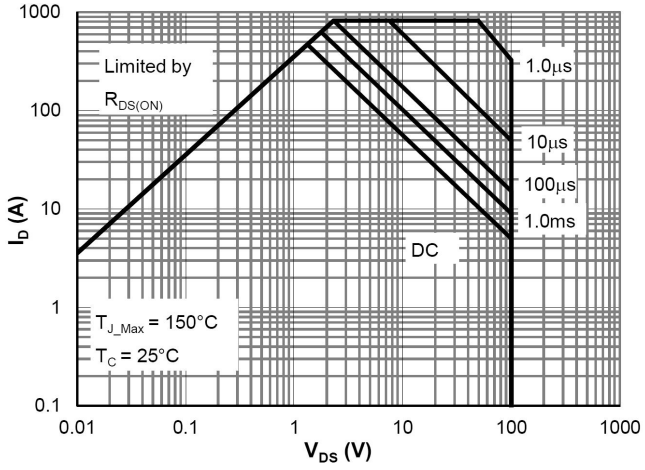
Capacitance Characteristics



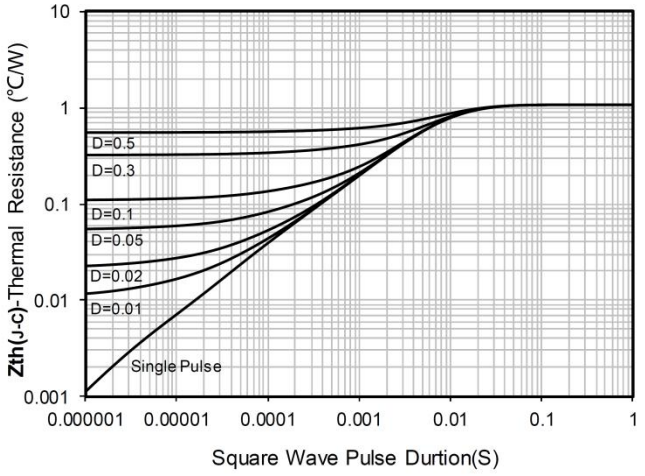
Current De-rating



Power De-rating

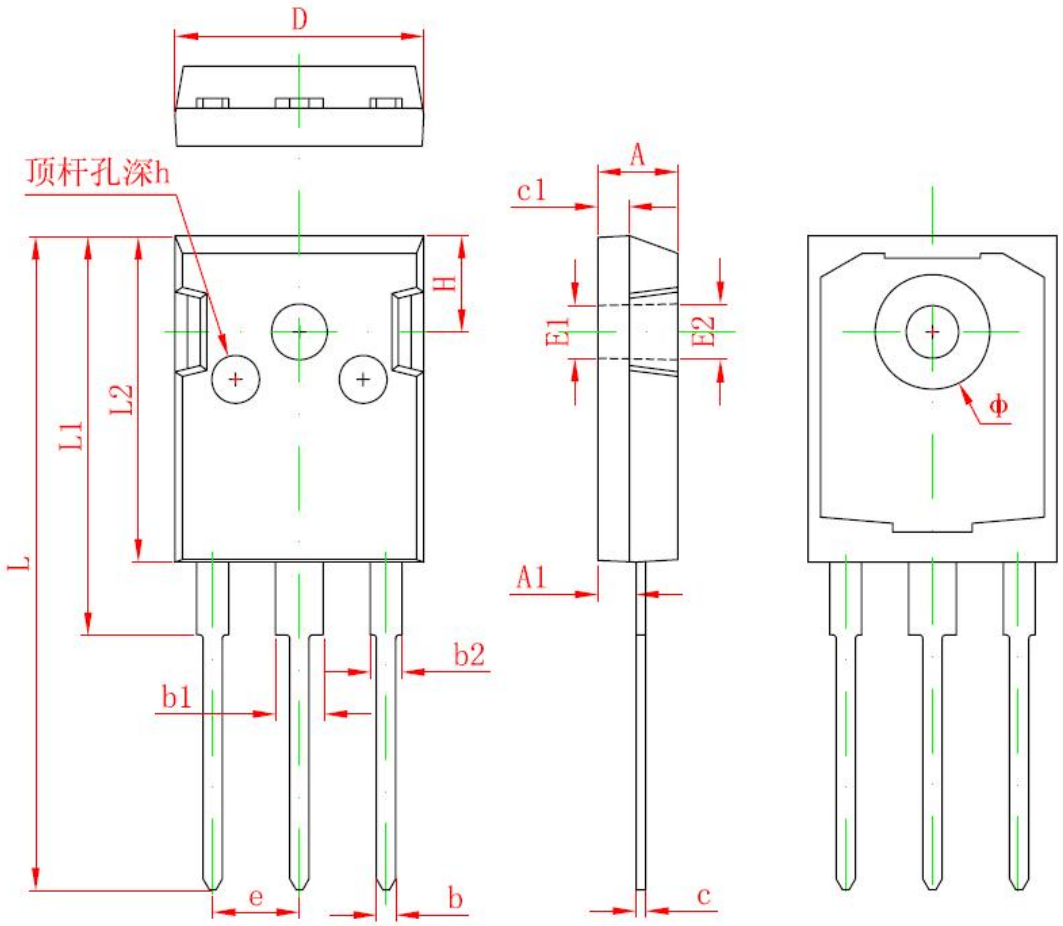


Maximum Safe Operating Area



Maximum Transient Thermal Impedance

TO-247 Package Information



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min.	Max.	Min.	Max.
A	4.850	5.150	0.191	0.200
A1	2.200	2.600	0.087	0.102
b	1.000	1.400	0.039	0.055
b1	2.800	3.200	0.110	0.126
b2	1.800	2.200	0.071	0.087
c	0.500	0.700	0.020	0.028
c1	1.900	2.100	0.075	0.083
D	15.450	15.750	0.608	0.620
E1	3.500 REF.		0.138 REF.	
E2	3.600 REF.		0.142 REF.	
L	40.900	41.300	1.610	1.626
L1	24.800	25.100	0.976	0.988
L2	20.300	20.600	0.799	0.811
Φ	7.100	7.300	0.280	0.287
e	5.450 TYP.		0.215 TYP.	
H	5.980 REF.		0.235 REF.	
h	0.000	0.300	0.000	0.012